RoHS

COMPLIANT

HALOGEN

FREE

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**PRODUCT SUMMARY** 

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS} = -10$  V

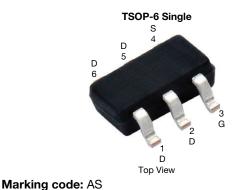
 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = -4.5 V

V<sub>DS</sub> (V)

Q<sub>g</sub> typ. (nC) I<sub>D</sub> (A) <sup>d</sup>

Configuration

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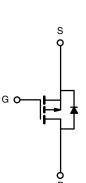
#### FEATURES

P-Channel 60 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- 100 % R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

· Load switch



P-Channel MOSFET

ORDERING INFORMATION				
Package	TSOP-6			
Lead (Pb)-free	Si3459BDV-T1-E3			
Lead (Pb)-free and halogen-free	Si3459BDV-T1-GE3			

-60

0.216

0.288

-2.9

Single

PARAMETER   Drain-source voltage   Gate-source voltage		SYMBOL	LIMIT	UNIT	
		V <sub>DS</sub>	-60	V	
		V <sub>GS</sub>	± 20	v	
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 25 °C		-2.9		
	T <sub>C</sub> = 70 °C		-2.3		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-2.2 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		-1.8 <sup>a, b</sup>	A	
Pulsed drain current		I <sub>DM</sub>	-8		
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-2.9		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-1.7 <sup>a, b</sup>		
Maximum power dissipation	T <sub>C</sub> = 25 °C		3.3		
	T <sub>C</sub> = 70 °C		2.1	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2 <sup>a,b</sup>	vv	
	T <sub>A</sub> = 70 °C		1.3 <sup>a, b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature)			260	-0	

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient <sup>a, c</sup>	t≤5 s	R <sub>thJA</sub>	53	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	32	38	0/11	

#### Notes

a. Surface mounted on 1" x 1" FR4 board

b.t=5s

c. Maximum under steady state conditions is 110  $^{\circ}\text{C/W}$ 

d. Based on  $T_C = 25 \ ^{\circ}C$ 

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### Si3459BDV

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PARAMETER SYMBOL TEST CONDITION		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-60	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-65	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-1	-	-3	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA
		$V_{DS}$ = -60 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C	-	-	-10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ -5 V, $V_{GS}$ = -10 V	-8	-	-	Α
Drain-source on-state resistance <sup>a</sup>	D	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.2 \text{ A}$	-	0.180	0.216	Ω
	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -1.9 \text{ A}$	-	0.240	0.288	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -2.2 A		4	-	S
Dynamic <sup>b</sup>			•		•	•
Input capacitance	C <sub>iss</sub>		-	350	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS}$ = -30 V, $V_{GS}$ = 0 V, f = 1 MHz	-	40	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	30	-	
Total gate charge	Qg	$V_{DS}$ = -30 V, $V_{GS}$ = -10 V, $I_{D}$ = -2.2 A	-	7.7	12	
			-	4.4	6.6	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -30 V, $V_{GS}$ = -4.5 V, $I_{D}$ = -2.2 A	-	1.3	-	nC
Gate-drain charge	Q <sub>gd</sub>			2.5	-	1
Gate resistance	R <sub>g</sub>	f = 1 MHz	2	10	20	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	45	68	
Rise time	t <sub>r</sub>	$V_{DD}$ = -30 V, $R_L$ = 16.7 $\Omega$	-	60	90	]
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -1.8 A, $V_{GEN}$ = -4.5 V, $R_g$ = 1 $\Omega$	-	16	25	
Fall time	t <sub>f</sub>		-	13	20	
Turn-on delay time	t <sub>d(on)</sub>		-	5	10	ns
Rise time	t <sub>r</sub>	$V_{DD}$ = -30 V, $R_L$ = 16.7 $\Omega$	-	12	20	
Turn-off delay time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ -1.8 A, $\text{V}_\text{GEN}$ = -10 V, $\text{R}_\text{g}$ = 1 $\Omega$	-	18	30	
Fall time	t <sub>f</sub>		-	10	15	
Drain-Source Body Diode Characteristi	cs			·		
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-2.9	۸
Pulse diode forward current	I <sub>SM</sub>		-	-	-8	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -1.8 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	28	56	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -1.8 A, di/dt = 100 A/μs,	-	35	70	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	23	-	
Reverse recovery rise time	t <sub>b</sub>		-	5	-	ns

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

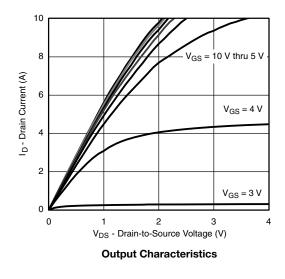
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

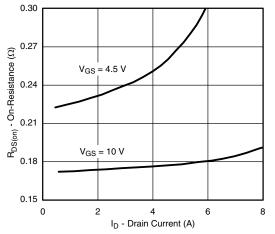
2



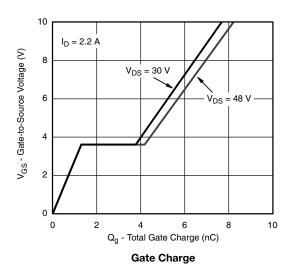
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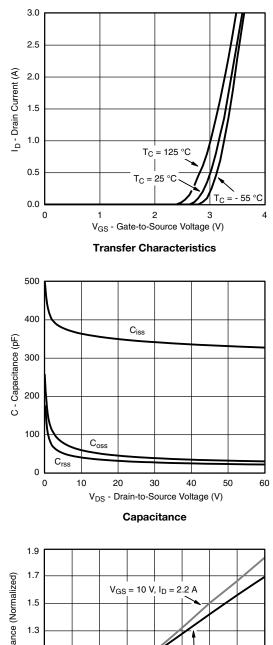
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

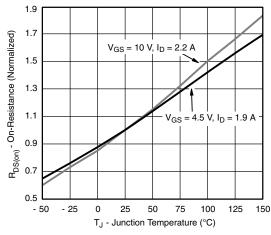




**On-Resistance vs. Drain Current and Gate Voltage** 







**On-Resistance vs. Junction Temperature** 

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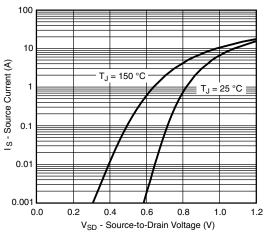
Document Number: 69954

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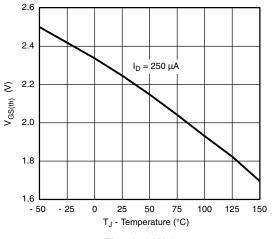


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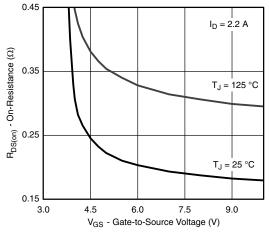
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



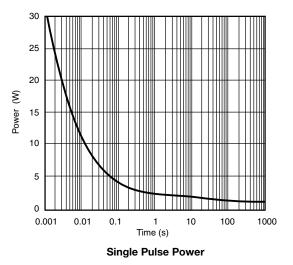
Source-Drain Diode Forward Voltage

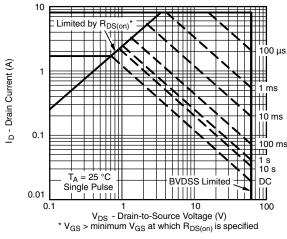






**On-Resistance vs. Gate-to-Source Voltage** 





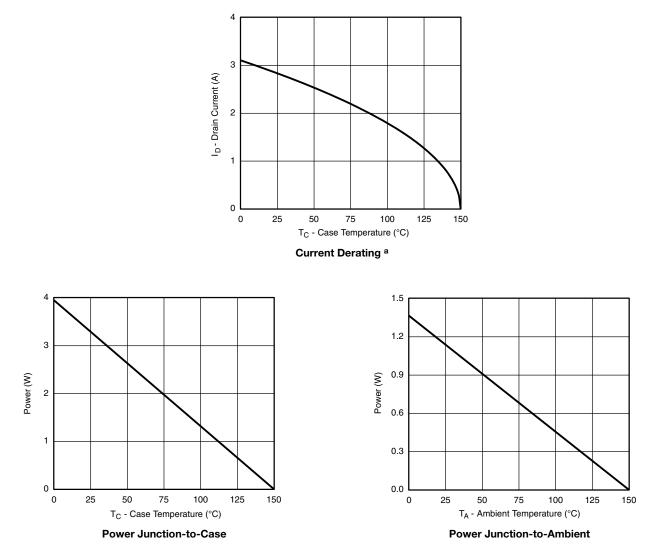
Safe Operating Area, Junction-to-Ambient

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



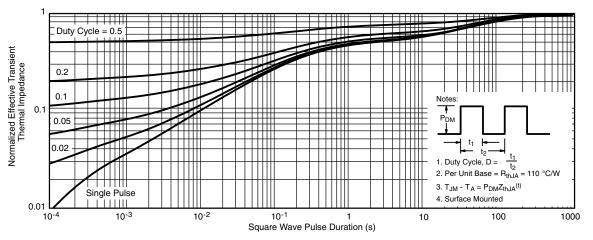
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

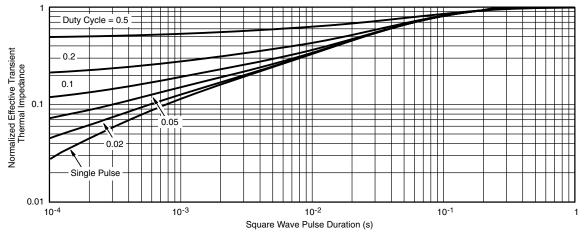


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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?69954">www.vishay.com/ppg?69954</a>.



Package Information

Vishay Siliconix

TSOP: 5/6-LEAD JEDEC Part Number: MO-193C









6-LEAD TSOP



	MILLIMETERS			INCHES					
Dim	Min	Nom	Max	Min	Nom	Max			
Α	0.91	-	1.10	0.036	-	0.043			
<b>A</b> <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004			
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039			
b	0.30	0.32	0.45	0.012	0.013	0.018			
С	0.10	0.15	0.20	0.004	0.006	0.008			
D	2.95	3.05	3.10	0.116	0.120	0.122			
Е	2.70	2.85	2.98	0.106	0.112	0.117			
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067			
е	0.95 BSC			0.0374 BSC					
<b>e</b> <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079			
L	0.32	-	0.50	0.012	-	0.020			
L <sub>1</sub>	0.60 Ref				0.024 Ref				
L <sub>2</sub>	0.25 BSC			0.010 BSC					
R	0.10	-	-	0.004	-	-			
θ	0°	4°	8°	0°	4°	8°			
$\theta_1$	7° Nom			7° Nom					
		ev. I, 18-Dec	c-06		ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540				

### **PAD** Pattern



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# **Recommended Land Pattern For TSOP-5L / TSOP-6L**





TSOP 5L





#### Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022	
DWG: 3010	

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